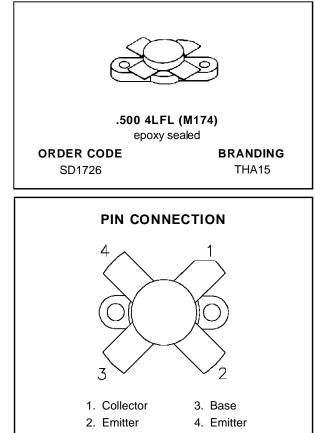


# RF & MICROWAVE TRANSISTORS HF SSB APPLICATIONS

- OPTIMIZED FOR SSB
- 30 MHz
- 50 VOLTS
- IMD -30 dB
- COMMON EMITTER
- GOLD METALLIZATION
- POUT = 150 W PEP MIN. WITH 14 dB GAIN



#### DESCRIPTION

The SD1726 is a 50 V epitaxial silicon NPN planar transistor designed primarily for SSB communications. This device utilizes emitter ballasting to achieve extreme ruggedness under severe operating conditions.

#### **ABSOLUTE MAXIMUM RATINGS** ( $T_{case} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit	
Vсво	Collector-Base Voltage	110	V	
V <sub>CEO</sub>	Collector-Emitter Voltage 55		V	
V <sub>EBO</sub>	Emitter-Base Voltage 4.0		V	
lc	Device Current	10		
PDISS	Power Dissipation	233	W	
TJ	Junction Temperature	+200	°C	
T <sub>STG</sub>	Storage Temperature	– 65 to +150	°C	

#### THERMAL DATA

RTH(j-c) Junction-Case Thermal Resistance	0.75	°C/W
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## **ELECTRICAL SPECIFICATIONS** ( $T_{case} = 25^{\circ}C$ )

#### STATIC

Symbol	Test Conditions	Value			Unit		
		Min.	Тур.	Max.			
ВVсво	I <sub>C</sub> = 100mA	$I_E = 0mA$		110			V
BVCES	I <sub>C</sub> = 100mA	$V_{BE} = 0V$		110	_		V
BV <sub>CEO</sub>	I <sub>C</sub> = 100mA	$I_B = 0mA$		55	—	_	V
BV <sub>EBO</sub>	I <sub>E</sub> = 10mA	$I_C = 0mA$		4.0	_		V
ICEO	$V_{CE} = 30V$	$I_E = 0mA$		_	_	5	mA
ICES	$V_{CE} = 60V$	$I_E = 0mA$			_	5	mA
h <sub>FE</sub>	$V_{CE} = 6V$	$I_{C} = 1.4A$		18	_	43.5	—

#### DYNAMIC

Symbol	Test Conditions			Value			Unit
Symbol				Min.	Тур.	Max.	Unit
Роит	f = 30 MHz	$V_{CE} = 50 V$	$I_{CQ} = 100 \text{mA}$	150			W
G <sub>P</sub> *	P <sub>OUT</sub> = 150 WPEP	$V_{CE} = 50 V$	$I_{CQ} = 100 \text{mA}$	14	_	—	dB
IMD*	P <sub>OUT</sub> = 150 WPEP	$V_{CE}=50\ V$	$I_{CQ} = 100 \text{mA}$	—	—	-30	dBc
ηc*	Pout = 150 WPEP	$V_{CE} = 50 V$	$I_{CQ} = 100 \text{mA}$	37			%
Сов	f = 1 MHz	$V_{CB}=50\ V$		_	_	220	pF

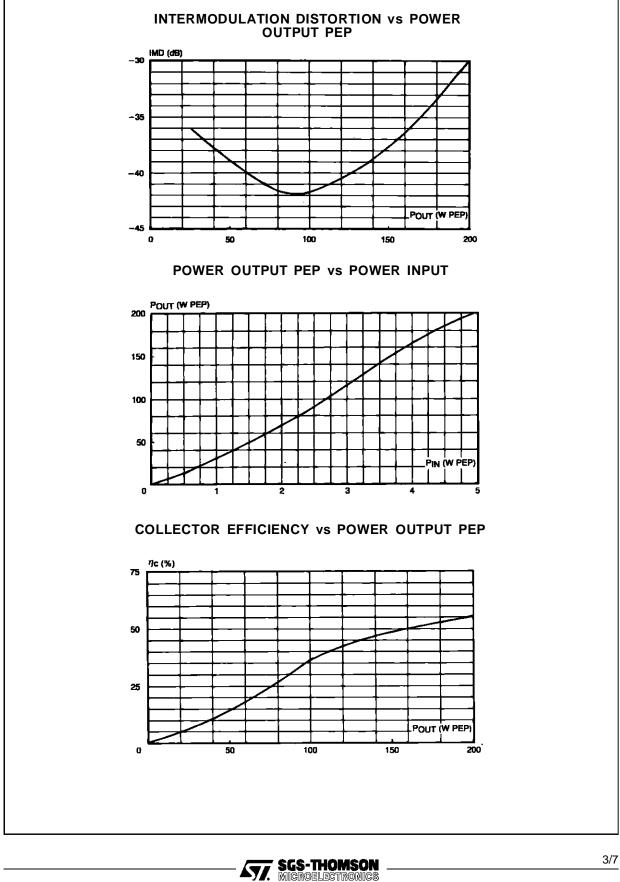
Note: The SD1726 is also usable in Class A at 40 V. Typical performance is:

 $P_{OUT} = 30 \text{ W PEP}, G_P = 14 \text{ dB}, \text{IMD} = -40 \text{dBc}$ 

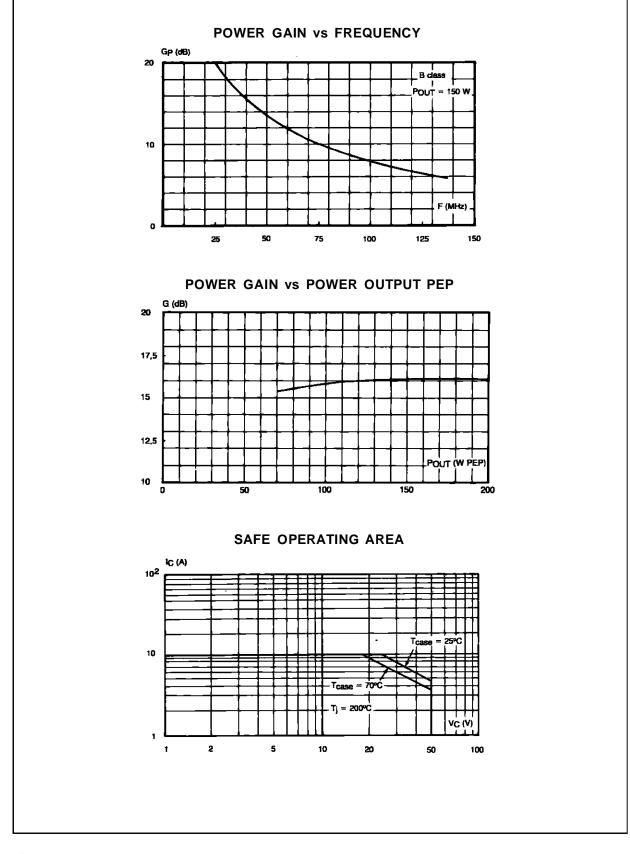
\*  $f_1 = 30.00 \mbox{ MHz}; f_2 = 30.001 \mbox{ MHz}$ 



#### **TYPICAL PERFORMANCE**



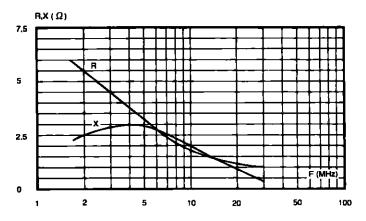
#### **TYPICAL PERFORMANCE (cont'd)**



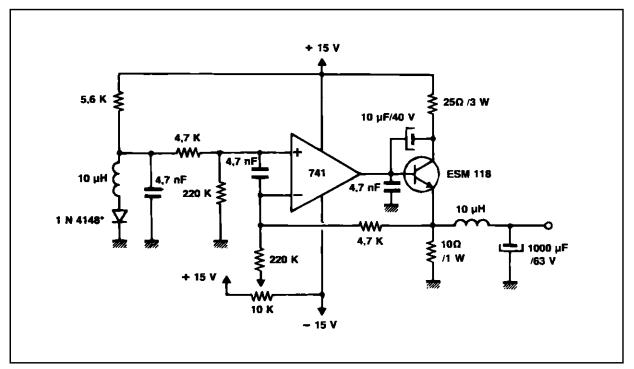


#### **IMPEDANCE DATA**

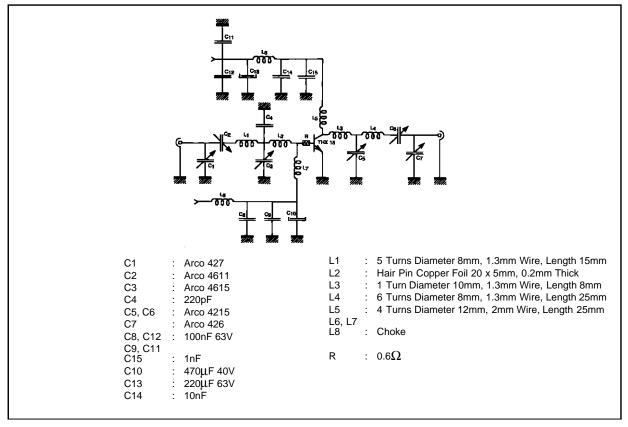
**TYPICAL INPUT IMPEDANCE** 



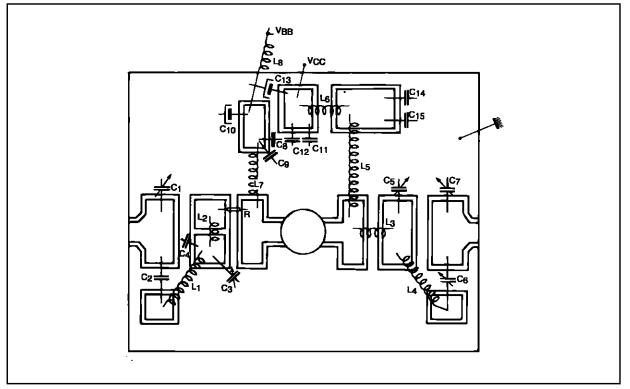
**BIAS CRCUIT** 



#### **TEST CIRCUIT - CLASS AB - 30 MHz**

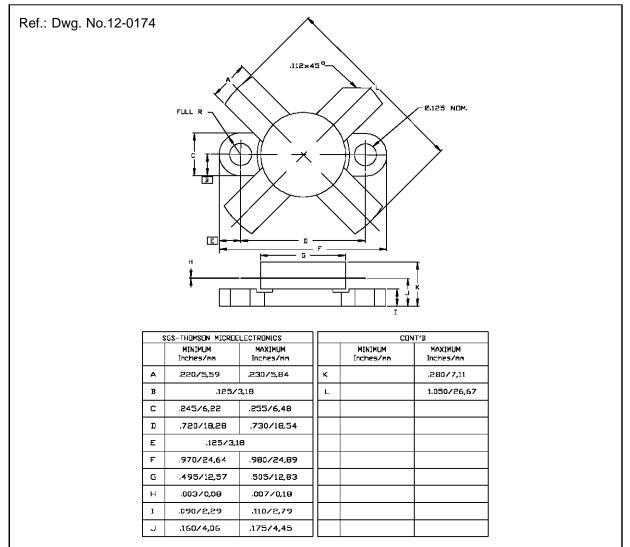


#### **MOUNTING CIRCUIT - CLASS AB - 30MHz**





#### PACKAGE MECHANICAL DATA



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